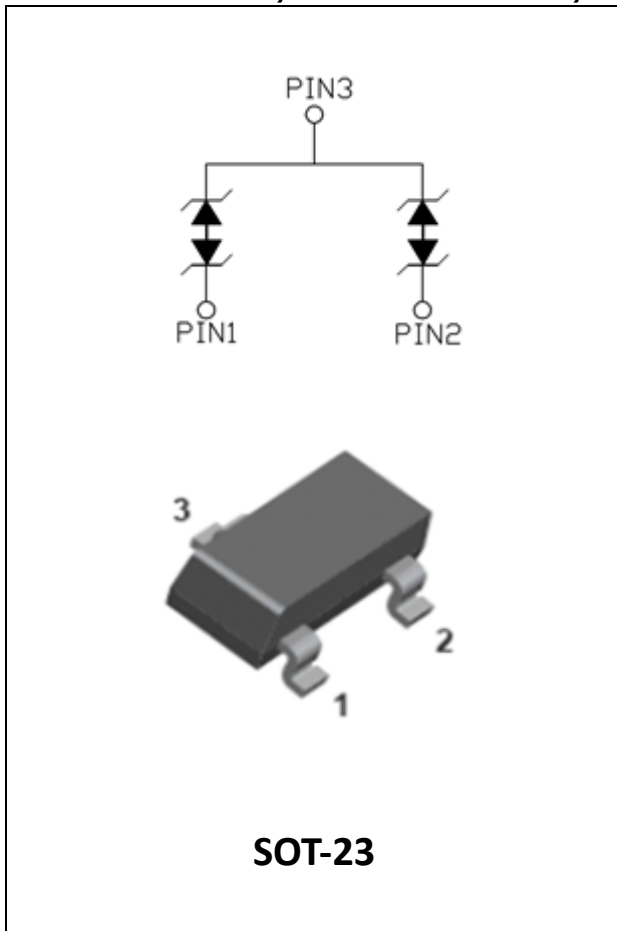


2-Line, Bi-directional, Transient Voltage Suppressor



Features

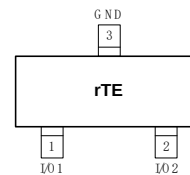
- Stand-off voltage: 27V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 4A (8/20 μs)
- Low leakage current
- Low clamping voltage
- Low clamping voltage:
- RoHS Compliant

Applications

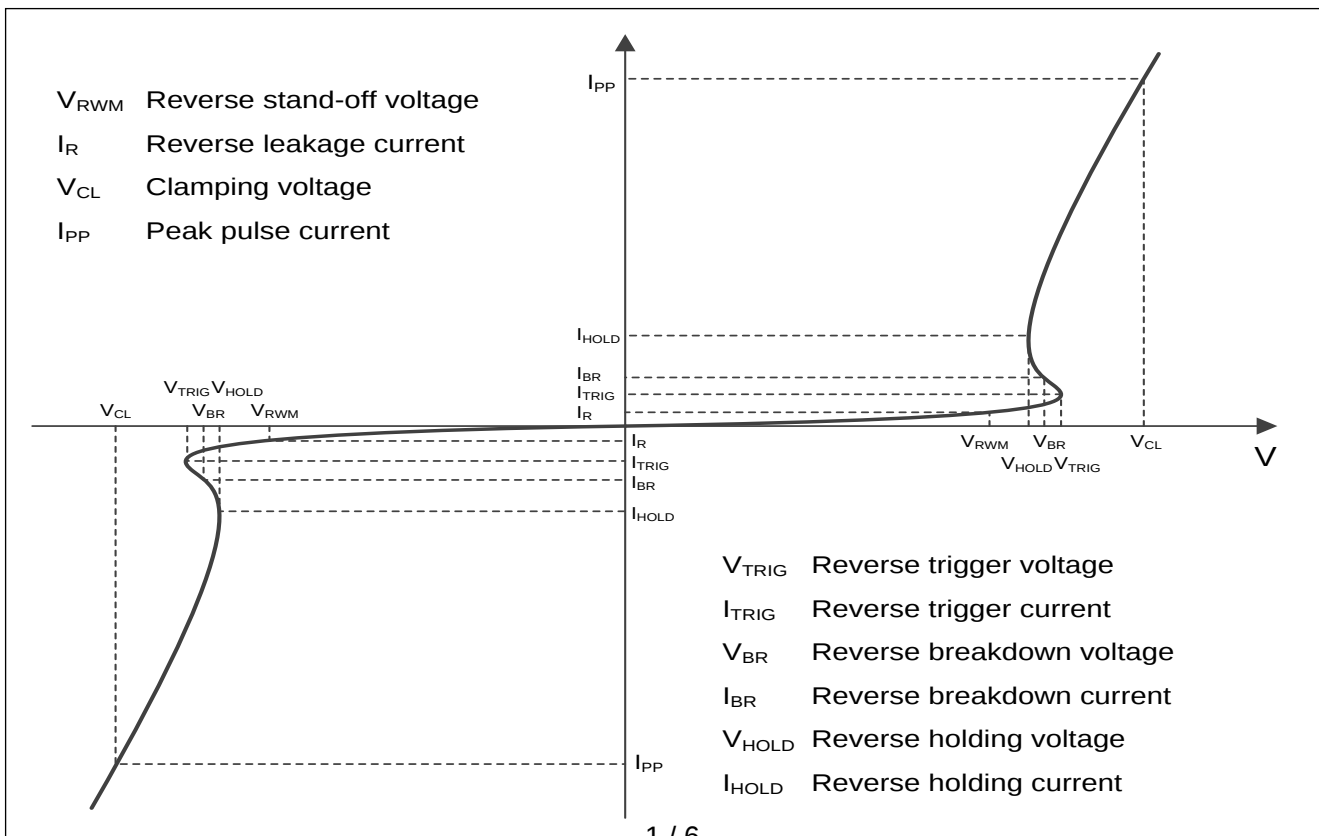
- ESD protection for in-vehicle network lines in automotive environments
- CAN-FD
- CAN
- Flex Ray
- SENT

Mechanical Data

- Package: SOT-23
- Case Material: "Green" Molding Compound
- Marking Information: See Below



■Definitions of electrical characteristics





ESDLC2702EB

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	172	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	4	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	
Junction temperature	T_J	125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				27
Reverse leakage current	I_R	μA	$V_{RWM} = 27V$,			0.1
Reverse breakdown voltage	$V_{(BR)}$	V	$I_T = 1mA$,	28		
Clamping voltage	V_{CL}	V	$I_{PP} = 1A$, $t_p = 8/20\mu s$			35
		V	$I_{PP} = 4A$, $t_p = 8/20\mu s$			43
Junction capacitance	CJ	pF	$V_R = 0V$, $f = 1MHz$ Any I/O pin to GND			13
			$V_R = 0V$, $f = 1MHz$ Between any I/O pin			7

Notes:

- (1). TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. RDYN is calculated from 4A to 16A.
- (2). Contact discharge mode, according to IEC61000-4-2.
- (3). Non-repetitive current pulse, according to IEC61000-4-5

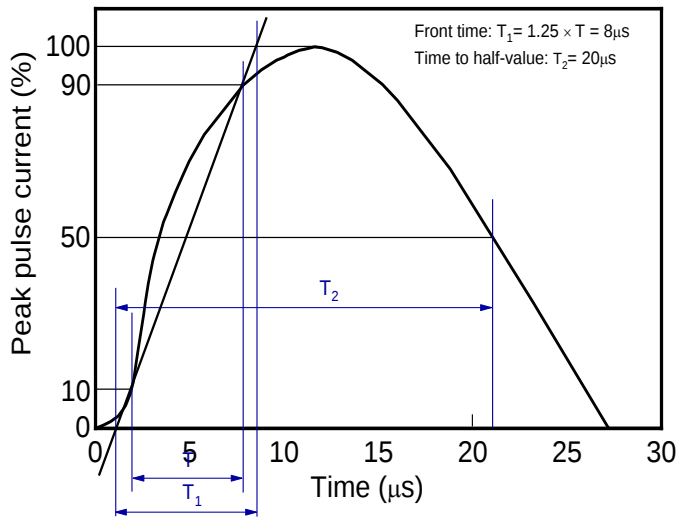
■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESDLC2702EB	F2	Approximate 8	3000	30000	120000	7 reel

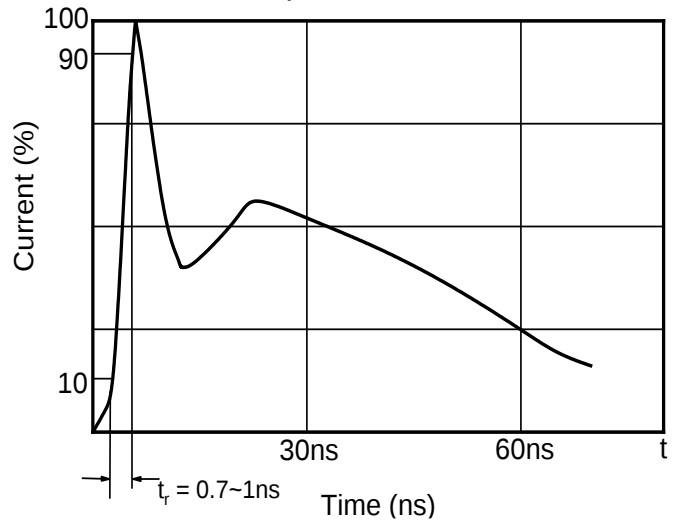


■ Characteristics (Typical)

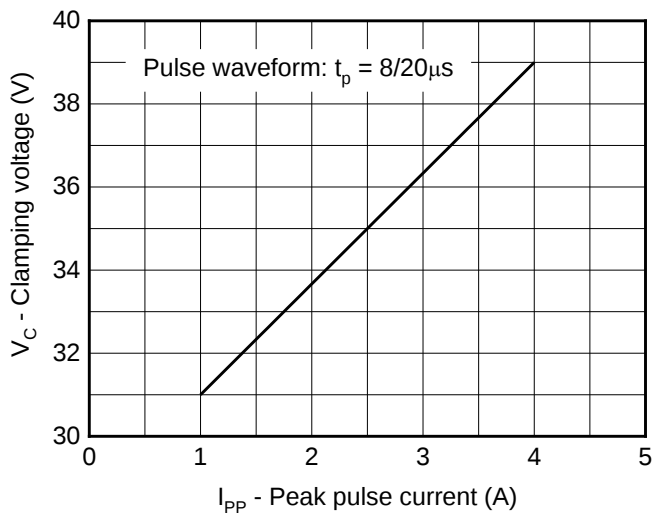
8/20 μ s waveform per IEC61000-4-5



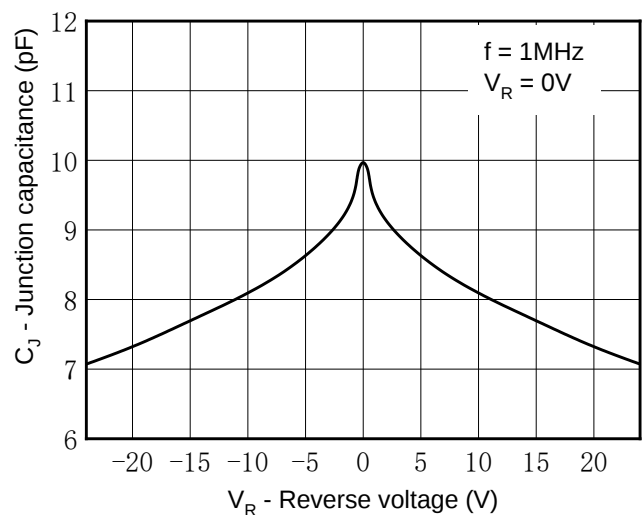
Contact discharge current waveform per IEC61000-4-2



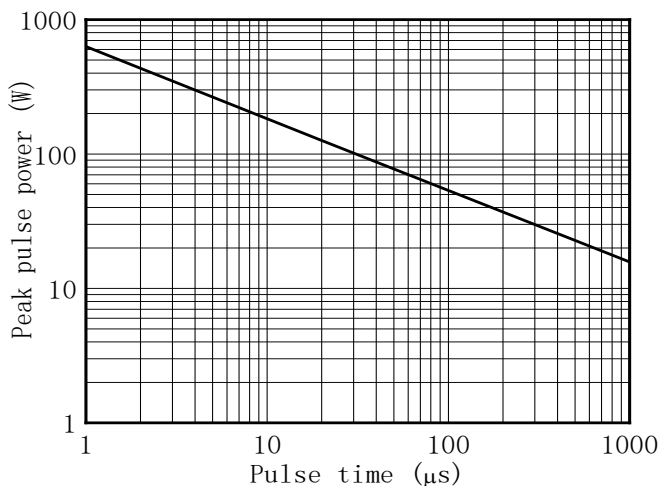
Clamping voltage vs. Peak pulse current



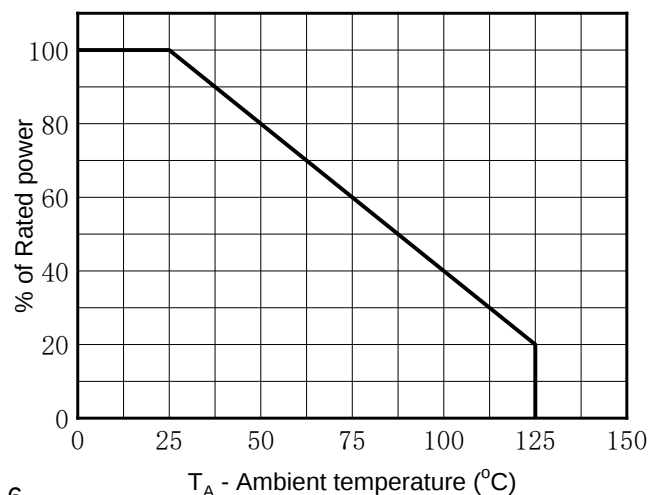
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time

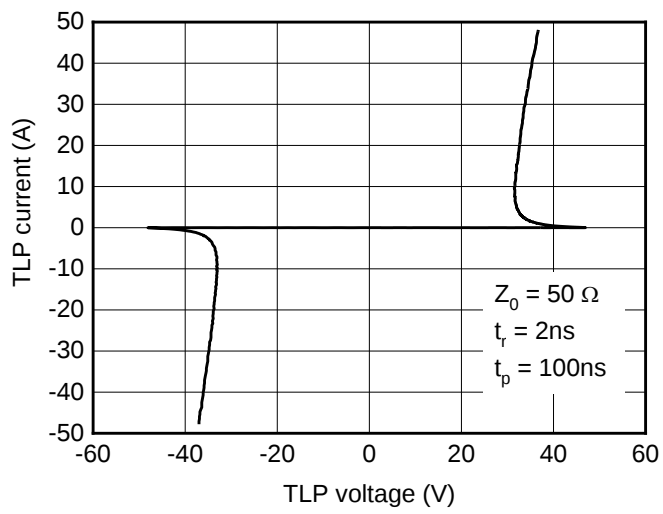


Power derating vs. Ambient temperature



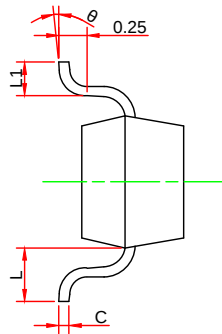
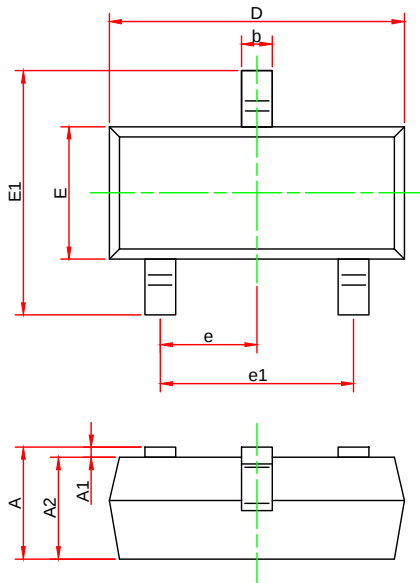


TLP Measurement



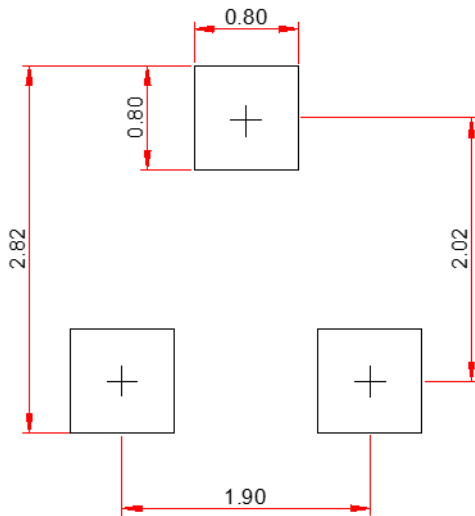


■ Outline Dimensions



Symbol	Dimensions in millimeters		
	Min.	Typ.	Max.
A	0.900	-	1.300
A1	0.000	-	0.100
A2	0.900	-	1.200
b	0.300	-	0.550
c	0.050	-	0.200
D	2.700	-	3.100
E	1.150	-	1.500
E1	2.100	-	2.700
e	0.950TYP		
e1	1.700	-	2.100
L	0.550REF		
L1	0.200	-	0.500
θ	0°	-	8°

■ Soldering Footprint



Unit:mm

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



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